

Vishay Siliconix

## N-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
	0.0027 at V <sub>GS</sub> = 4.5 V	34				
12	0.0032 at V <sub>GS</sub> = 2.5 V	31	33 nC			
	$0.0040$ at $V_{GS} = 1.8 \text{ V}$	28				

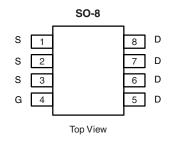
#### **FEATURES**

- · Halogen-free
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

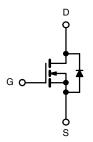


#### **APPLICATIONS**

Low V<sub>IN</sub> DC/DC



Ordering Information: Si4838BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>S</b> T <sub>A</sub> = 25 °C, unles	ss otherwise no	oted	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	$V_{DS}$	12	V	
Gate-Source Voltage		$V_{GS}$	± 8	<b> </b>
	T <sub>C</sub> = 25 °C		34	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	_ [	27	
Continuous Diain Current (1) = 150 C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	22.5 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		18.0 <sup>b, c</sup>	A
Pulsed Drain Current	I <sub>DM</sub>	70		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I-	5.1	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.2 <sup>b, c</sup>	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20	
Avalanche Energy		E <sub>AS</sub>	20	mJ
	T <sub>C</sub> = 25 °C		5.7	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	3.6	w
	T <sub>A</sub> = 25 °C		2.50 <sup>b, c</sup>	v
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>	
Operating Junction and Storage Temperature R	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b,d</sup>	t ≤ 10 s	$R_{thJA}$	39	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	18	22	C/VV		

- a. Based on T<sub>C</sub> = 25 °C.
  b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.

### **Si4838BDY**

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		<u>'</u>				I	
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$	12			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050A		12		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 3.2			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4		1.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zana Oata Walkana Buain Ouwant	I <sub>DSS</sub>	V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 12 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	°C 10		μΑ		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	30			Α	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		0.0021	0.0027	32 Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 12 A		0.0025	0.0032		
	, ,	V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 10 A		0.0031	0.0040		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		105		S	
Dynamic <sup>b</sup>		<u> </u>				l	
Input Capacitance	C <sub>iss</sub>			5760		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1730			
Reverse Transfer Capacitance	C <sub>rss</sub>			1145			
Tievelee Transier Supusiance	Qg	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		56	84	nC	
Total Gate Charge		30 30 2		33	50		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 6 \text{ V}, V_{GS} = 2.5 \text{ V}, I_{D} = 10 \text{ A}$		5.9			
Gate-Drain Charge	Q <sub>gd</sub>			12.5			
Gate Resistance	$R_{g}$	f = 1 MHz	0.2	0.65	1.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			25	50		
Rise Time	t <sub>r</sub>	$V_{DD} = 6 \text{ V}, R_{L} = 0.6 \Omega$		29	55		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		140	240		
Fall Time	t <sub>f</sub>			35	65		
Turn-On Delay Time	t <sub>d(on)</sub>			12	24	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 6 \text{ V}, R_{L} = 0.6 \Omega$		13	26		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$		56	100		
Fall Time	t <sub>f</sub>	-		10	20		
<b>Drain-Source Body Diode Characteristi</b>	cs	<u>'</u>					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			5.1		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				70	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 3 A		0.60	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			52	100	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	10 A W/W 100 A/ T 55 50		40	80	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		21			
Reverse Recovery Rise Time	t <sub>b</sub>		31			ns	

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

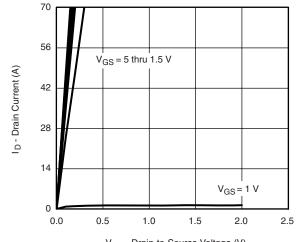
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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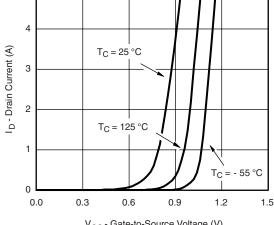


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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

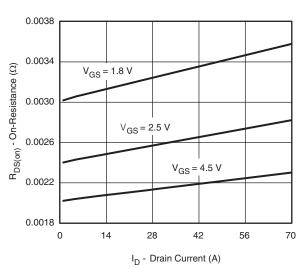


 $V_{\mbox{\footnotesize DS}}$  - Drain-to-Source Voltage (V)

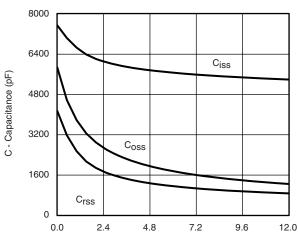


V<sub>GS</sub> - Gate-to-Source Voltage (V) **Transfer Characteristics** 

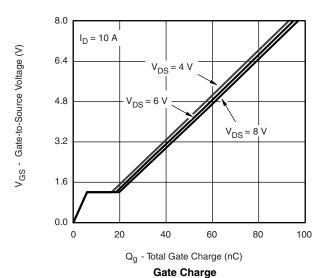




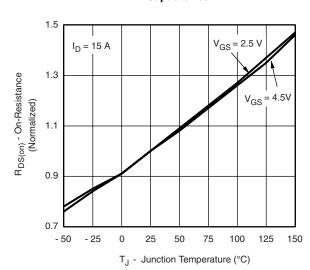
On-Resistance vs. Drain Current and Gate Voltage



V<sub>DS</sub> - Drain-to-Source Voltage (V)



#### Capacitance



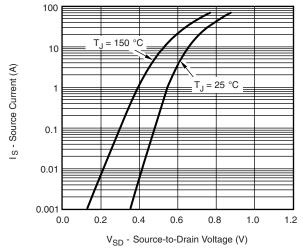
On-Resistance vs. Junction Temperature

### **Si4838BDY**

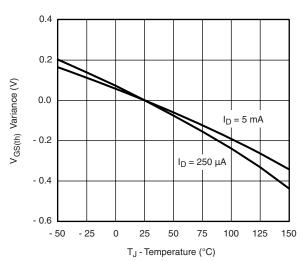
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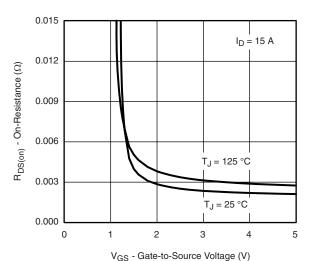
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



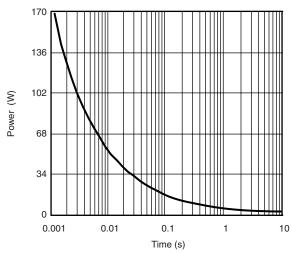
#### Source-Drain Diode Forward Voltage



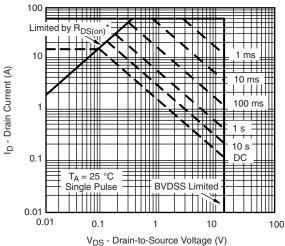
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



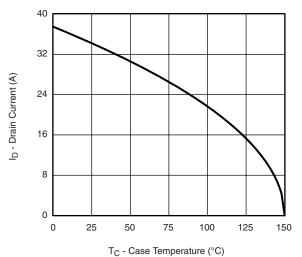
\*  $V_{GS}$  > minimum  $V_{GS}$  at whicht  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

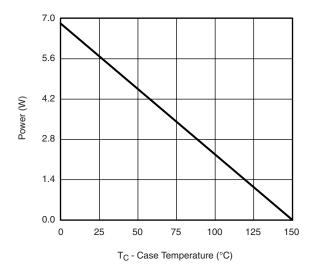


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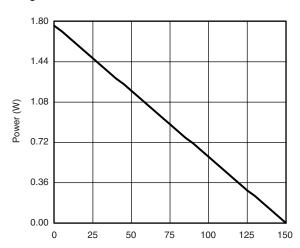
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### **Current Derating\***



Power, Junction-to-Foot



T<sub>A</sub> - Ambient Temperature (°C)

Power, Junction-to-Ambient

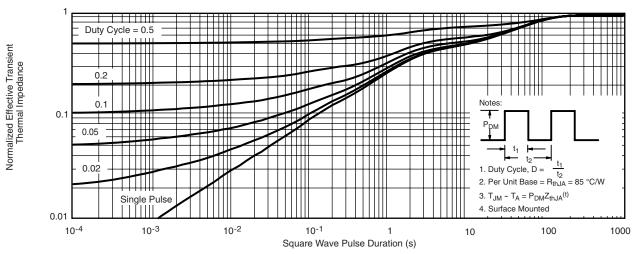
\*The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

### **Si4838BDY**

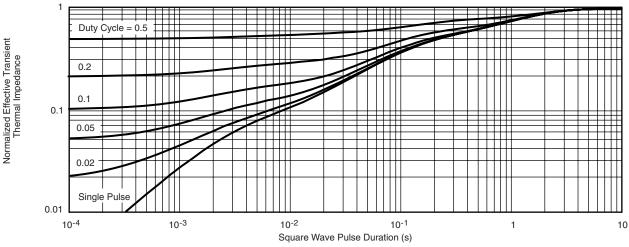
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?68964">http://www.vishay.com/ppg?68964</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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